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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I ² C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, HLVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 24x12b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f25k42-i-ss

4.8.3 MAPPING THE ACCESS BANK IN INDEXED LITERAL OFFSET MODE

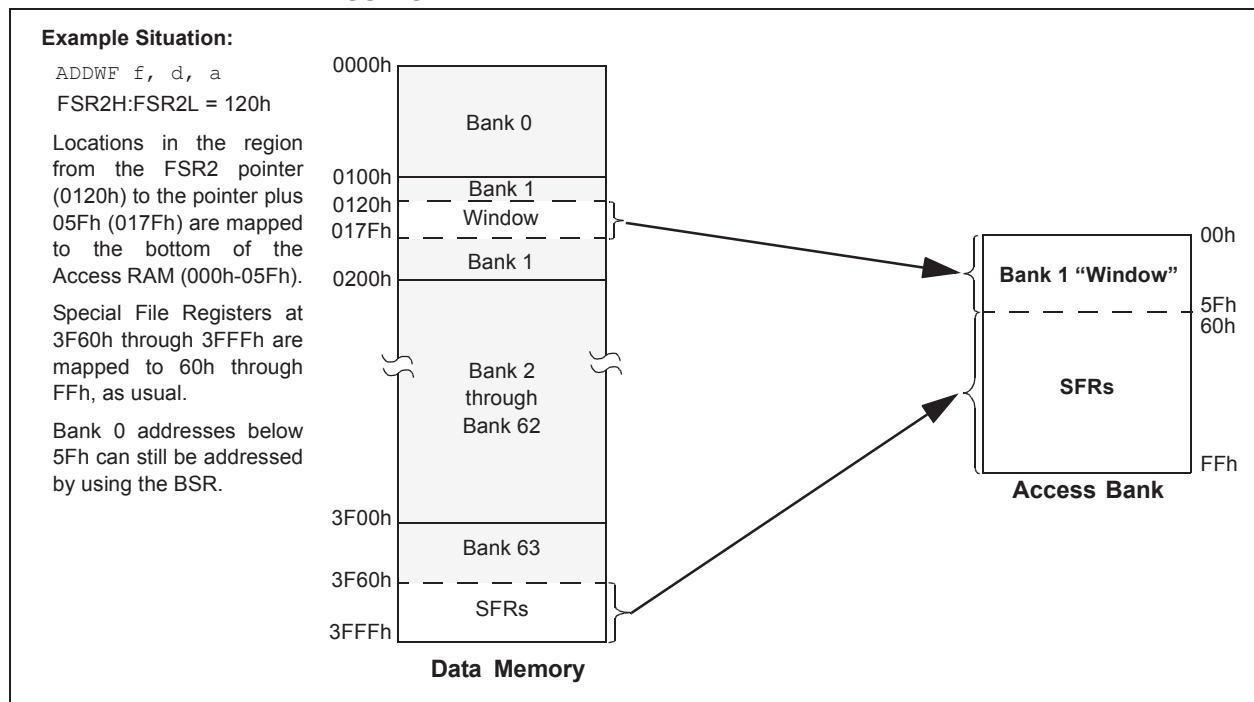
The use of Indexed Literal Offset Addressing mode effectively changes how the first 96 locations of Access RAM (00h to 5Fh) are mapped. Rather than containing just the contents of the bottom section of Bank 0, this mode maps the contents from a user defined “window” that can be located anywhere in the data memory space. The value of FSR2 establishes the lower boundary of the addresses mapped into the window, while the upper boundary is defined by FSR2 plus 95 (5Fh). Addresses in the Access RAM above 5Fh are mapped as previously described (see [Section 4.5.2 “Access Bank”](#)). An example of Access Bank remapping in this addressing mode is shown in [Figure 4-8](#).

Remapping of the Access Bank applies *only* to operations using the Indexed Literal Offset mode. Operations that use the BSR (Access RAM bit is ‘1’) will continue to use direct addressing as before.

4.9 PIC18 Instruction Execution and the Extended Instruction Set

Enabling the extended instruction set adds eight additional commands to the existing PIC18 instruction set. These instructions are executed as described in [Section 43.2 “Extended Instruction Set”](#).

FIGURE 4-8: REMAPPING THE ACCESS BANK WITH INDEXED LITERAL OFFSET ADDRESSING



7.0 DEVICE CONFIGURATION INFORMATION

The Device Configuration Information (DCI) is a dedicated region in the Program memory space mapped from 3FFF00h to 3FFF09h. The data stored in these locations is read-only and cannot be erased or modified.

Refer to [Table 7-1: Device Configuration Information](#) for the complete DCI table address and description. The DCI holds information about the device which is useful for programming and Bootloader applications. These locations are read-only and cannot be erased or modified.

TABLE 7-1: DEVICE CONFIGURATION INFORMATION

ADDRESS	Name	DESCRIPTION	VALUE	UNITS
3FFF00h-3FFF01h	ERSIZ	Erase Row Size	32	Words
3FFF02h-3FFF03h	WLSIZ	Number of write latches	64	
3FFF04h-3FFF05h	URSIZ	Number of User Rows	See Table 7-2	Rows
3FFF06h-3FFF07h	EESIZ	EE Data memory size	256	Bytes
3FFF08h-3FFF09h	PCNT	Pin Count	28	Pins

TABLE 7-2: MEMORY SIZE AND NUMBER OF USER ROWS

Part Name	Memory size	Number of user rows
PIC18(L)F24K42	8K	256
PIC18(L)F25K42	16K	512

7.1 DIA and DCI Access

The DIA and DCI addresses are read-only and cannot be erased or modified. See [Section 15.2 “Device Information Area, Device Configuration Area, User ID, Device ID and Configuration Word Access”](#) for more information on accessing these memory locations.

Development tools, such as device programmers and debuggers, may be used to read the DIA and DCI regions, similar to the Device ID and Revision ID.

REGISTER 23-3: TxCLK: TIMERx CLOCK REGISTER

U-0	U-0	U-0	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u
—	—	—	CS<4:0>				
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

u = unchanged

bit 7-5

Unimplemented: Read as '0'

bit 4-0

CS<4:0>: Timerx Clock Source Selection bits

CS	Timer1	Timer3	Timer5
	Clock Source	Clock Source	Clock Source
11111-10001	Reserved	Reserved	Reserved
10000	CLC4	CLC4	CLC4
01111	CLC3	CLC3	CLC3
01110	CLC2	CLC2	CLC2
01101	CLC1	CLC1	CLC1
01100	TMR5 overflow	TMR5 overflow	Reserved
01011	TMR3 overflow	Reserved	TMR3 overflow
01010	Reserved	TMR1 overflow	TMR1 overflow
01001	TMR0 overflow	TMR0 overflow	TMR0 overflow
01000	CLKREF	CLKREF	CLKREF
00111	SOSC	SOSC	SOSC
00110	MFINTOSC (32 kHz)	MFINTOSC (32 kHz)	MFINTOSC (32 kHz)
00101	MFINTOSC (500 kHz)	MFINTOSC (500 kHz)	MFINTOSC (500 kHz)
00100	LFINTOSC	LFINTOSC	LFINTOSC
00011	HFINTOSC	HFINTOSC	HFINTOSC
00010	Fosc	Fosc	Fosc
00001	Fosc/4	Fosc/4	Fosc/4
00000	T1CKIPPS	T3CKIPPS	T5CKIPPS

28.10 Auto-Shutdown

Auto-shutdown is a method to immediately override the CWG output levels with specific overrides that allow for safe shutdown of the circuit. The shutdown state can be either cleared automatically or held until cleared by software. The auto-shutdown circuit is illustrated in [Figure 28-14](#).

28.10.1 SHUTDOWN

The shutdown state can be entered by either of the following two methods:

- Software generated
- External Input

28.10.1.1 Software Generated Shutdown

Setting the SHUTDOWN bit of the CWGxAS0 register will force the CWG into the shutdown state.

When the auto-restart is disabled, the shutdown state will persist as long as the SHUTDOWN bit is set.

When auto-restart is enabled, the SHUTDOWN bit will clear automatically and resume operation on the next rising edge event. The SHUTDOWN bit indicates when a shutdown condition exists. The bit may be set or cleared in software or by hardware.

28.10.1.2 External Input Source

External shutdown inputs provide the fastest way to safely suspend CWG operation in the event of a Fault condition. When any of the selected shutdown inputs goes active, the CWG outputs will immediately go to the specified override levels without software delay. The override levels are selected by the LSB<1:0> and LSAC<1:0> bits of the CWGxAS0 register ([Register](#)). Several input sources can be selected to cause a shutdown condition. All input sources are active-low. The sources are:

- Pin selected by CWGxPPS
- Timer2 post-scaled output
- Timer4 post-scaled output
- Timer6 post-scaled output
- Comparator 1 output
- Comparator 2 output
- CLC2 output

Shutdown input sources are individually enabled by the ASxE bits of the CWGxAS1 register ([Register 28-7](#)).

Note: Shutdown inputs are level sensitive, not edge sensitive. The shutdown state cannot be cleared, except by disabling auto-shutdown, as long as the shutdown input level persists.

28.10.1.3 Pin Override Levels

The levels driven to the CWG outputs during an auto-shutdown event are controlled by the LSB<1:0> and LSAC<1:0> bits of the CWGxAS0 register ([Register](#)). The LSB<1:0> bits control CWGxB/D output levels, while the LSAC<1:0> bits control the CWGxA/C output levels.

28.10.1.4 Auto-Shutdown Interrupts

When an auto-shutdown event occurs, either by software or hardware setting SHUTDOWN, the CWGxIF flag bit of the PIR7 register is set ([Register 9-5](#)).

28.11 Auto-Shutdown Restart

After an auto-shutdown event has occurred, there are two ways to resume operation:

- Software controlled
- Auto-restart

In either case, the shut-down source must be cleared before the restart can take place. That is, either the shutdown condition must be removed, or the corresponding ASxE bit must be cleared.

28.11.1 SOFTWARE-CONTROLLED RESTART

If the REN bit of the CWGxAS0 register is clear (REN = 0), the CWG module must be restarted after an auto-shutdown event through software.

Once all auto-shutdown sources are removed, the software must clear SHUTDOWN. Once SHUTDOWN is cleared, the CWG module will resume operation upon the first rising edge of the CWG data input.

Note: The SHUTDOWN bit cannot be cleared in software if the auto-shutdown condition is still present.

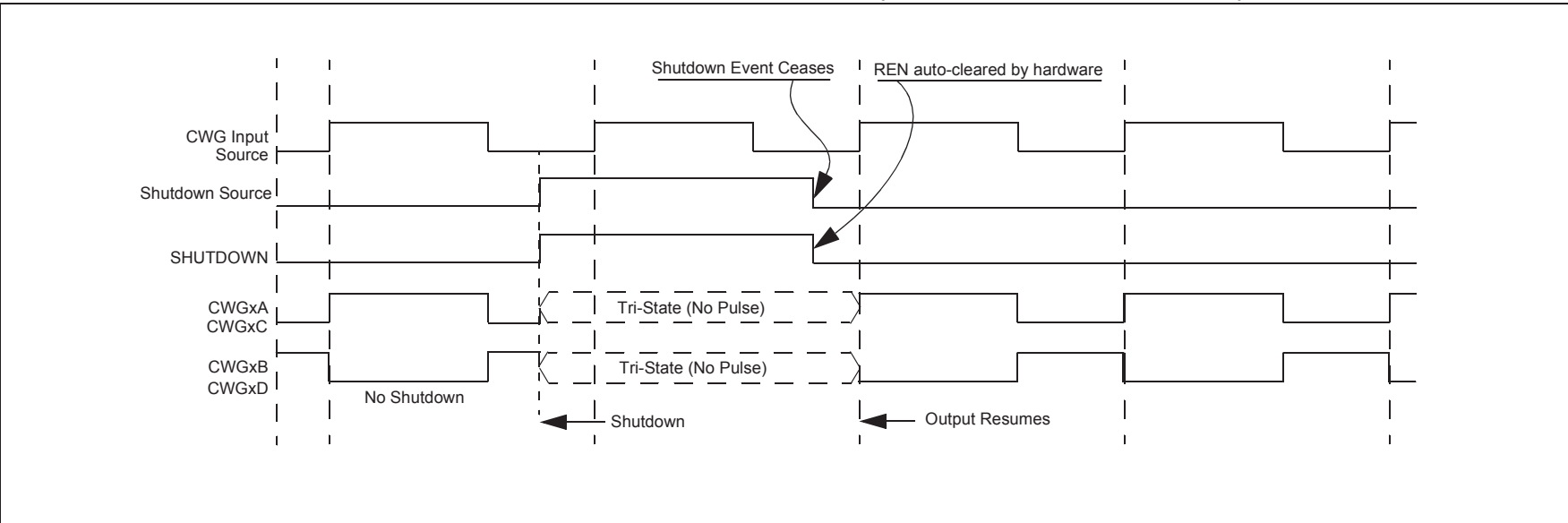
28.11.2 AUTO-RESTART

If the REN bit of the CWGxAS0 register is set (REN = 1), the CWG module will restart from the shutdown state automatically.

Once all auto-shutdown conditions are removed, the hardware will automatically clear SHUTDOWN. Once SHUTDOWN is cleared, the CWG module will resume operation upon the first rising edge of the CWG data input.

Note: The SHUTDOWN bit cannot be cleared in software if the auto-shutdown condition is still present.

FIGURE 28-16: SHUTDOWN FUNCTIONALITY, AUTO-RESTART ENABLED (REN = 1, LSAC = 01, LSB0 = 01)



28.14 Register Definitions: CWG Control

Long bit name prefixes for the CWG peripheral is shown in Table 28-1. Refer to Section 1.4.2.2 “Long Bit Names” for more information.

TABLE 28-1:

Peripheral	Bit Name Prefix
CWG1	CWG1
CWG2	CWG2
CWG3	CWG3

REGISTER 28-1: CWGxCON0: CWG CONTROL REGISTER 0

R/W-0/0	R/W/HC-0/0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
EN	LD ⁽¹⁾	—	—	—	MODE<2:0>		
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as ‘0’

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

‘1’ = Bit is set

‘0’ = Bit is cleared

HC = Bit is cleared by hardware

bit 7

EN: CWGx Enable bit

1 = Module is enabled

0 = Module is disabled

bit 6

LD: CWGx Load Buffers bit⁽¹⁾

1 = Dead-band count buffers to be loaded on CWG data rising edge, following first falling edge after this bit is set

0 = Buffers remain unchanged

bit 5-3

Unimplemented: Read as ‘0’

bit 2-0

MODE<2:0>: CWGx Mode bits

111 = Reserved

110 = Reserved

101 = CWG outputs operate in Push-Pull mode

100 = CWG outputs operate in Half-Bridge mode

011 = CWG outputs operate in Reverse Full-Bridge mode

010 = CWG outputs operate in Forward Full-Bridge mode

001 = CWG outputs operate in Synchronous Steering mode

000 = CWG outputs operate in Asynchronous Steering mode

Note 1: This bit can only be set after EN = 1; it cannot be set in the same cycle when EN is set.

TABLE 28-2: SUMMARY OF REGISTERS ASSOCIATED WITH CWG

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
CWGxCON0	EN	LD	—	—	—	MODE<2:0>			427
CWGxCON1	—	—	IN	—	POLD	POLC	POLB	POLA	428
CWGxCLK	—	—	—	—	—	—	—	CS	429
CWGxISM	—	—	—	—	—	ISM<2:0>			430
CWGxSTR	OVRD	OVRC	OVRB	OVRA	STRD	STRC	STRB	STRA	431
CWGxAS0	SHUTDOWN	REN	LSBD<1:0>		LSAC<1:0>		—	—	432
CWGxAS1	—	—	AS5E	AS4E	AS3E	AS2E	AS1E	AS0E	433
CWGxDBR	—	—	DBR<5:0>						434
CWGxDBF	—	—	DBF<5:0>						434

Legend: — = unimplemented locations read as '0'. Shaded cells are not used by CWG.

30.8 NCO Control Registers

REGISTER 30-1: NCO1CON: NCO CONTROL REGISTER

R/W-0/0	U-0	R-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
EN	—	OUT	POL	—	—	—	PFM
bit 7							bit 0

Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

u = Bit is unchanged

x = Bit is unknown

-n/n = Value at POR and BOR/Value at all other Resets

'1' = Bit is set

'0' = Bit is cleared

- bit 7 **EN:** NCO1 Enable bit
1 = NCO1 module is enabled
0 = NCO1 module is disabled
- bit 6 **Unimplemented:** Read as '0'
- bit 5 **OUT:** NCO1 Output bit
Displays the current output value of the NCO1 module.
- bit 4 **POL:** NCO1 Polarity
1 = NCO1 output signal is inverted
0 = NCO1 output signal is not inverted
- bit 3-1 **Unimplemented:** Read as '0'
- bit 0 **PFM:** NCO1 Pulse Frequency Mode bit
1 = NCO1 operates in Pulse Frequency mode
0 = NCO1 operates in Fixed Duty Cycle mode, divide by 2

REGISTER 33-12: UxP1H: UART PARAMETER 1 HIGH REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0/0
—	—	—	—	—	—	—	P1<8>
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-6 **Unimplemented:** Read as '0'

bit 0 **P1<8>:** Most Significant Bit of Parameter 1

DMX mode:

Most Significant bit of number of bytes to transmit between Start Code and automatic Break generation

DALI Control Device mode:

Most Significant bit of idle time delay after which a Forward Frame is sent. Measured in half-bit periods

DALI Control Gear mode:

Most Significant bit of delay between the end of a Forward Frame and the start of the Back Frame
Measured in half-bit periods

Other modes:

Not used

REGISTER 33-13: UxP1L: UART PARAMETER 1 LOW REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
P1<7:0>							
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **P1<7:0>:** Least Significant Bits of Parameter 1

DMX mode:

Least Significant Byte of number of bytes to transmit between Start Code and automatic Break generation

DALI Control Device mode:

Least Significant Byte of idle time delay after which a Forward Frame is sent. Measured in half-bit periods

DALI Control Gear mode:

Least Significant Byte of delay between the end of a Forward Frame and the start of the Back Frame
Measured in half-bit periods

LIN mode:

PID to transmit (Only Least Significant 6 bits used)

Asynchronous Address mode:

Address to transmit (9th transmit bit automatically set to '1')

Other modes:

Not used

FIGURE 34-7: CLOCKING DETAIL-MASTER MODE, CKE/SMP = 0/0

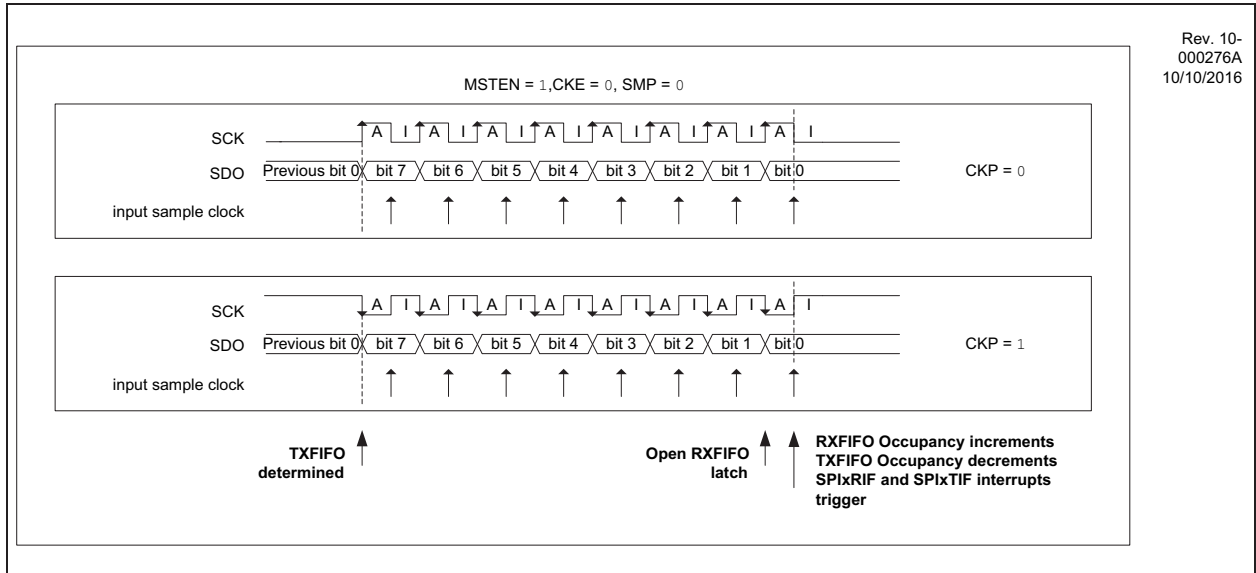


FIGURE 34-8: CLOCKING DETAIL - MASTER MODE, CKE/SMP = 1/1

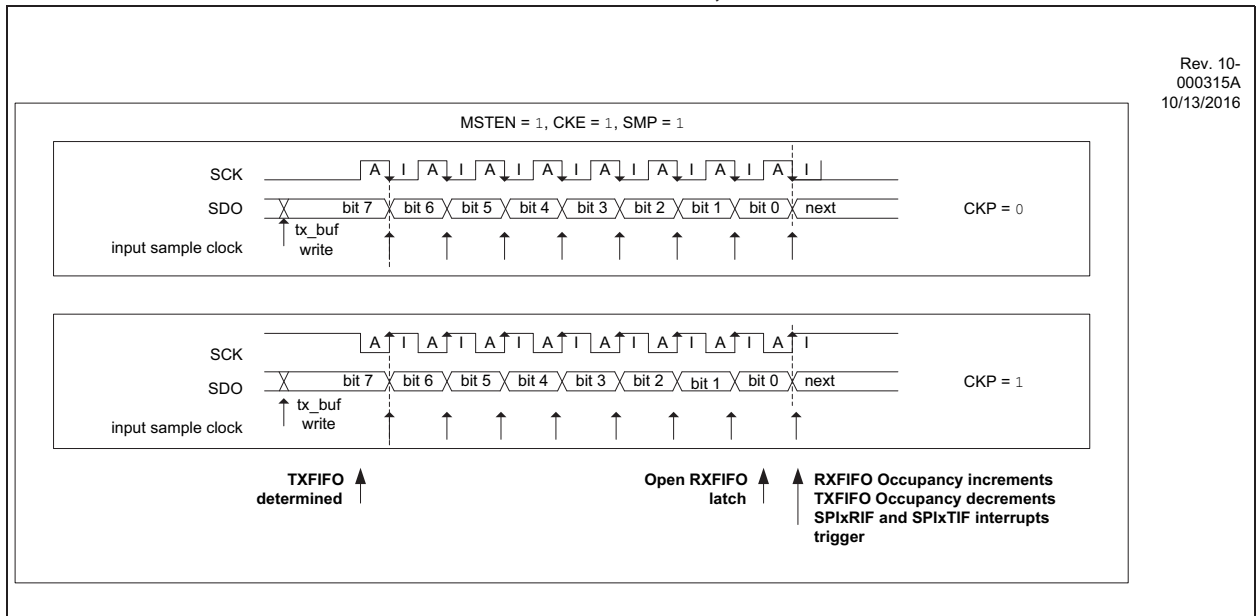


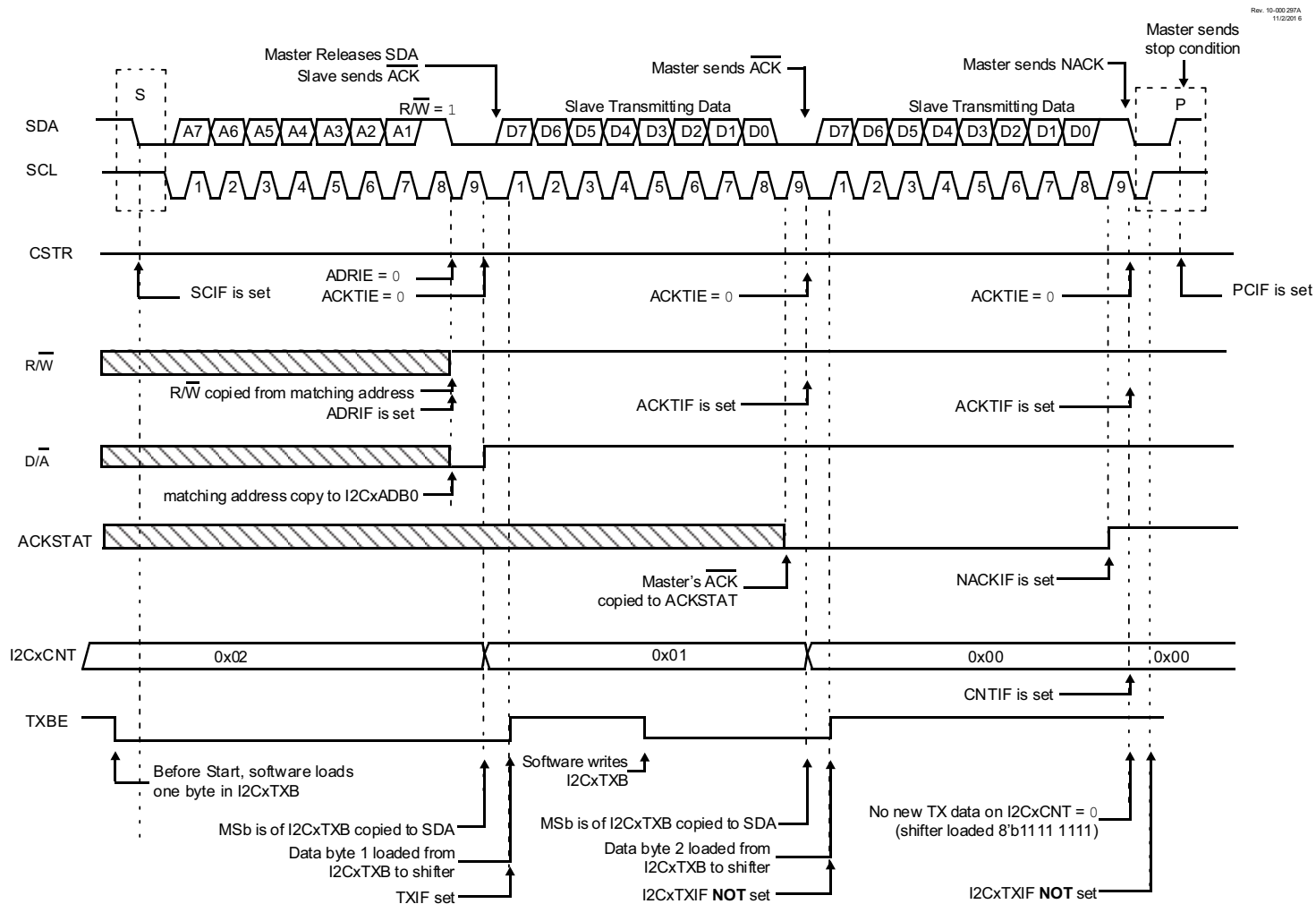
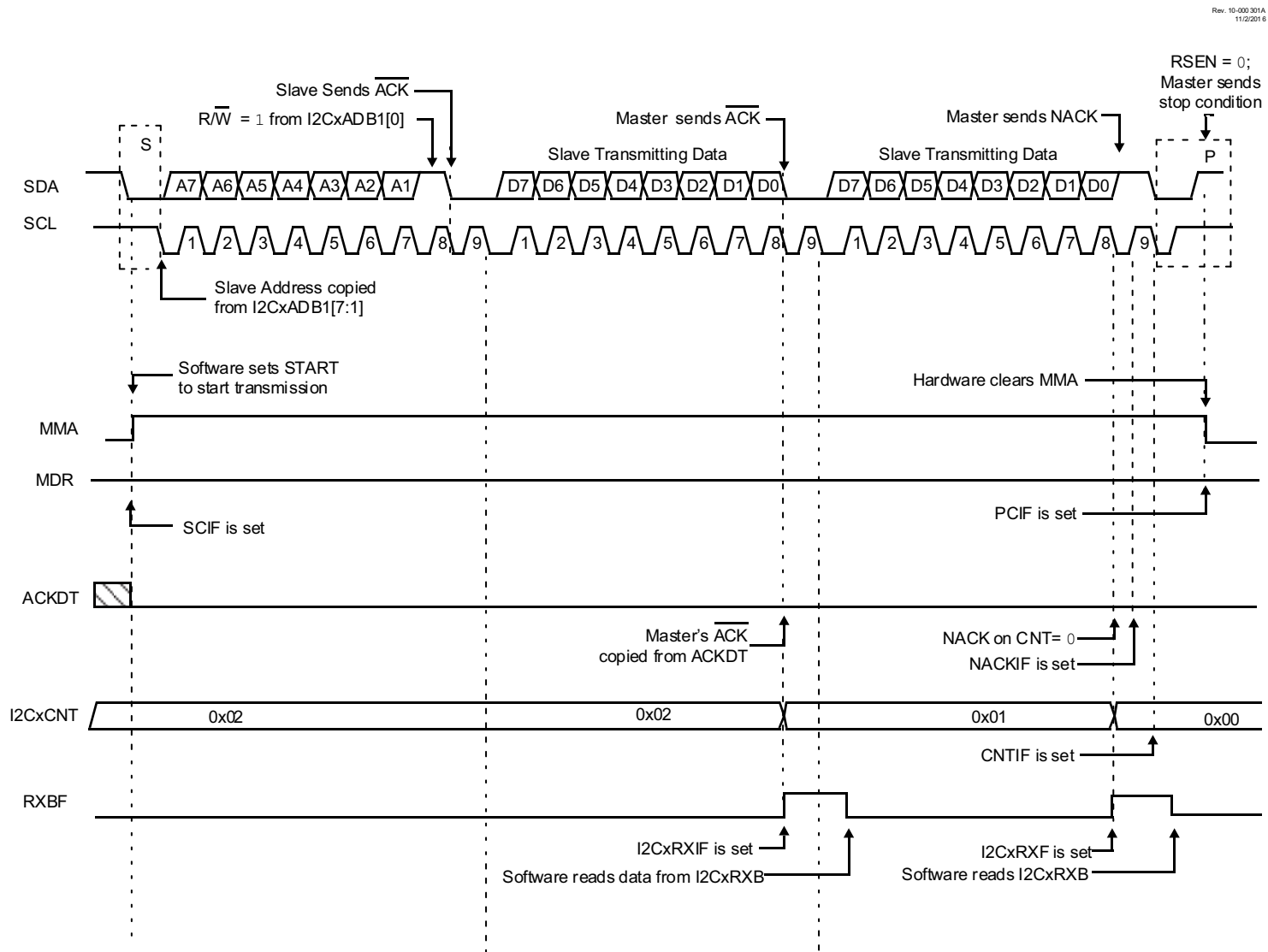
FIGURE 35-10: I²C SLAVE, 7-BIT ADDRESS, TRANSMISSION (NO CLOCK STRETCHING)

FIGURE 35-20: I²C MASTER, 7-BIT ADDRESS, RECEPTION

PIC18(L)F24/25K42

REGISTER 35-6: I2CxSTAT0 – I²C STATUS REGISTER 0

R-0	R-0	R-0	R-0	R-0	U-0	U-0	U-0
BFRE ⁽³⁾	SMA	MMA	R ^(1, 2)	D	—	—	—
bit 7							bit 0

Legend:

R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set HC = Hardware clear

- bit 7 **BFRE:** Bus Free Status bit⁽³⁾
1 = Indicates the I²C bus is Idle
Both SCL and SDA have been high for time-out selected by I2CCON2<BFRET<1:0>> bits.
I2CCLK must select a valid clock source for this bit to function.
0 = Bus not Idle (When no I2CCLK is selected, this bit remains clear)
- bit 6 **SMA:** Slave Module Active Status bit
1 = Set after the 8th falling SCL edge of a received matching 7-bit slave address
Set after the 8th falling SCL edge of a received matching 10-bit slave **low** address
Set after the 8th falling SCL edge of a received matching 10-bit slave **high** w/ read address, only after a previous matching high and low w/ write.
0 = Cleared by any Restart/Stop detected on the bus
Cleared by BTOIF and BCLIF conditions
- bit 5 **MMA:** Master Module Active Status bit
1 = Master Mode state machine is active
Set when master state machine asserts a Start on bus
0 = Master state machine is Idle
Cleared when BCLIF is set
Cleared when Stop is shifted out by master.
Cleared for BTOIF condition, after the master successfully shifts out a Stop condition.
- bit 4 **R:** Read Information bit ^(1, 2)
1 = Indicates the last matching received (high) address was a Read request
0 = Indicates the last matching received (high) address was a Write
- bit 3 **D:** Data bit
1 = Indicates the last byte received or transmitted was data
0 = Indicates the last byte received or transmitted was an address
- bit 2-0 **Unimplemented:** Read as 1'b0

- Note 1:** This bit holds the R bit information following the last received address match. Addresses transmitted by the Master or appearing on the bus without a match do not affect this bit.
- 2:** Clock requests and input from I2CxCLK register are disabled in Slave modes.
- 3:** Software must use the EN bit to force Master or Slave hardware to Idle.

41.6 Operation During Sleep

When enabled, the HLVD circuitry continues to operate during Sleep. If the device voltage crosses the trip point, the HLVDIF bit will be set and the device will wake up from Sleep. Device execution will continue from the interrupt vector address if interrupts have been globally enabled.

41.7 Operation During Idle and Doze Modes

In both Idle and Doze modes, the module is active and events are generated if peripheral is enabled.

41.8 Operation During Freeze

When in Freeze mode, no new event or interrupt can be generated. The state of the LRDY bit is frozen.

Register reads and writes through the CPU interface are allowed.

41.9 Effects of a Reset

A device Reset forces all registers to their Reset state. This forces the HLVD module to be turned off.

RCALL

Relative Call

Syntax:	RCALL n				
Operands:	$-1024 \leq n \leq 1023$				
Operation:	(PC) + 2 → TOS, (PC) + 2 + 2n → PC				
Status Affected:	None				
Encoding:	<table><tr><td>1101</td><td>1nnn</td><td>nnnn</td><td>nnnn</td></tr></table>	1101	1nnn	nnnn	nnnn
1101	1nnn	nnnn	nnnn		
Description:	Subroutine call with a jump up to 1K from the current location. First, return address (PC + 2) is pushed onto the stack. Then, add the 2's complement number '2n' to the PC. Since the PC will have incremented to fetch the next instruction, the new address will be PC + 2 + 2n. This instruction is a 2-cycle instruction.				
Words:	1				
Cycles:	2				

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'n' PUSH PC to stack	Process Data	Write to PC
No operation	No operation	No operation	No operation

Example: HERE RCALL Jump

Before Instruction

PC = Address (HERE)

After Instruction

PC = Address (Jump)

TOS = Address (HERE + 2)

RESET

Reset

Syntax:	RESET								
Operands:	None								
Operation:	Reset all registers and flags that are affected by a MCLR Reset.								
Status Affected:	All								
Encoding:	<table><tr><td>0000</td><td>0000</td><td>1111</td><td>1111</td></tr></table>	0000	0000	1111	1111				
0000	0000	1111	1111						
Description:	This instruction provides a way to execute a MCLR Reset by software.								
Words:	1								
Cycles:	1								
Q Cycle Activity:									
	<table><tr><td>Q1</td><td>Q2</td><td>Q3</td><td>Q4</td></tr><tr><td>Decode</td><td>Start Reset</td><td>No operation</td><td>No operation</td></tr></table>	Q1	Q2	Q3	Q4	Decode	Start Reset	No operation	No operation
Q1	Q2	Q3	Q4						
Decode	Start Reset	No operation	No operation						

Example: RESET

After Instruction

Registers = Reset Value

Flags* = Reset Value

SUBWF Subtract W from f

Syntax:	SUBWF f{,d{,a}}			
Operands:	$0 \leq f \leq 255$ $d \in [0,1]$ $a \in [0,1]$			
Operation:	$(f) - (W) \rightarrow \text{dest}$			
Status Affected:	N, OV, C, DC, Z			
Encoding:	0101	11da	ffff	ffff
Description:	<p>Subtract W from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default).</p> <p>If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.</p> <p>If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See Section 43.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.</p>			
Words:	1			
Cycles:	1			

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example 1: SUBWF REG, 1, 0

Before Instruction

REG	=	3
W	=	2
C	=	?

After Instruction

REG	=	1
W	=	2
C	=	1 ; result is positive
Z	=	0
N	=	0

Example 2: SUBWF REG, 0, 0

Before Instruction

REG	=	2
W	=	2
C	=	?

After Instruction

REG	=	2
W	=	0
C	=	1 ; result is zero
Z	=	1
N	=	0

Example 3: SUBWF REG, 1, 0

Before Instruction

REG	=	1
W	=	2
C	=	?

After Instruction

REG	=	FFh ;(2's complement)
W	=	2
C	=	0 ; result is negative
Z	=	0
N	=	1

SUBWFB Subtract W from f with Borrow

Syntax:	SUBWFB f {,d {,a}}							
Operands:	$0 \leq f \leq 255$ $d \in [0,1]$ $a \in [0,1]$							
Operation:	$(f) - (W) - (\overline{C}) \rightarrow \text{dest}$							
Status Affected:	N, OV, C, DC, Z							
Encoding:	<table border="1"><tr><td>0101</td><td>10da</td><td>ffff</td><td>ffff</td></tr></table>				0101	10da	ffff	ffff
0101	10da	ffff	ffff					
Description:	<p>Subtract W and the CARRY flag (borrow) from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f' (default). If 'a' is '0', the Access Bank is selected. If 'a' is '1', the BSR is used to select the GPR bank.</p> <p>If 'a' is '0' and the extended instruction set is enabled, this instruction operates in Indexed Literal Offset Addressing mode whenever $f \leq 95$ (5Fh). See Section 43.2.3 "Byte-Oriented and Bit-Oriented Instructions in Indexed Literal Offset Mode" for details.</p>							
Words:	1							
Cycles:	1							
Q Cycle Activity:								

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example 1: SUBWFB REG, 1, 0

Before Instruction

REG	=	19h	(0001 1001)
W	=	0Dh	(0000 1101)
C	=	1	

After Instruction

REG	=	0Ch	(0000 1100)
W	=	0Dh	(0000 1101)
C	=	1	
Z	=	0	
N	=	0	; result is positive

Example 2: SUBWFB REG, 0, 0

Before Instruction

REG	=	1Bh	(0001 1011)
W	=	1Ah	(0001 1010)
C	=	0	

After Instruction

REG	=	1Bh	(0001 1011)
W	=	00h	
C	=	1	
Z	=	1	; result is zero
N	=	0	

Example 3: SUBWFB REG, 1, 0

Before Instruction

REG	=	03h	(0000 0011)
W	=	0Eh	(0000 1110)
C	=	1	

After Instruction

REG	=	F5h	(1111 0101) ; [2's comp]
W	=	0Eh	(0000 1110)
C	=	0	
Z	=	0	
N	=	1	; result is negative

TABLE 46-2: SUPPLY CURRENT (IDD)^(1,2,4)

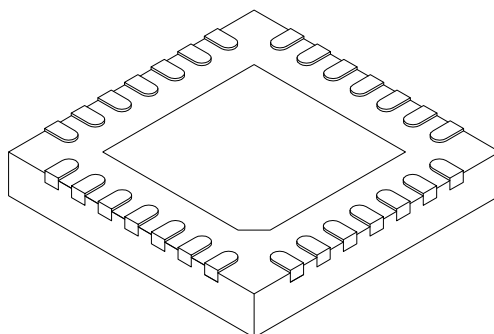
PIC18LF24/25K42				Standard Operating Conditions (unless otherwise stated)					
PIC18F24/25K42									
Param. No.	Symbol	Device Characteristics	Min.	Typ. [†]	Max.	Units	Conditions		
							VDD	Note	
D100	IDD _{XT4}	XT = 4 MHz	—	560	1000	μA	3.0V		
D100	IDD _{XT4}	XT = 4 MHz	—	730	1100	μA	3.0V		
D100A	IDD _{XT4}	XT = 4 MHz	—	370	—	μA	3.0V	PMD's all 1's	
D100A	IDD _{XT4}	XT = 4 MHz	—	590	—	μA	3.0V	PMD's all 1's	
D101	IDD _{HFO16}	HFINTOSC = 16 MHz	—	2.2	3.7	mA	3.0V		
D101	IDD _{HFO16}	HFINTOSC = 16 MHz	—	2.3	3.8	mA	3.0V		
D101A	IDD _{HFO16}	HFINTOSC = 16 MHz	—	1.4	—	mA	3.0V	PMD's all 1's	
D101A	IDD _{HFO16}	HFINTOSC = 16 MHz	—	1.4	—	mA	3.0V	PMD's all 1's	
D102	IDD _{HFOPLL}	HFINTOSC = 64 MHz	—	8.0	11.1	mA	3.0V		
D102	IDD _{HFOPLL}	HFINTOSC = 64 MHz	—	8.0	11.2	mA	3.0V		
D102A	IDD _{HFOPLL}	HFINTOSC = 64 MHz	—	4.8	—	mA	3.0V	PMD's all 1's	
D102A	IDD _{HFOPLL}	HFINTOSC = 64 MHz	—	4.8	—	mA	3.0V	PMD's all 1's	
D103	IDD _{HSPLL64}	HS+PLL = 64 MHz	—	8.0	11.1	mA	3.0V		
D103	IDD _{HSPLL64}	HS+PLL = 64 MHz	—	8.0	11.2	mA	3.0V		
D103A	IDD _{HSPLL64}	HS+PLL = 64 MHz	—	4.8	—	mA	3.0V	PMD's all 1's	
D103A	IDD _{HSPLL64}	HS+PLL = 64 MHz	—	4.8	—	mA	3.0V	PMD's all 1's	
D104	IDD _{IDLE}	IDLE mode, HFINTOSC = 16 MHz	—	1.8	—	mA	3.0V		
D104	IDD _{IDLE}	IDLE mode, HFINTOSC = 16 MHz	—	1.8	—	mA	3.0V		
D105	IDD _{DOZE} ⁽³⁾	DOZE mode, HFINTOSC = 16 MHz, Doze Ratio = 16	—	1.8	—	mA	3.0V		
D105	IDD _{DOZE} ⁽³⁾	DOZE mode, HFINTOSC = 16 MHz, Doze Ratio = 16	—	1.9	—	mA	3.0V		

[†] Data in "Typ." column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note**
- 1: The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins are outputs driven low; MCLR = VDD, WDT disabled.
 - 2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.
 - 3: $IDD_{DOZE} = [IDD_{IDLE} * (N-1)/N] + IDD_{HFO} / N$ where N = DOZE Ratio (Register 12-2).
 - 4: PMD bits are all in the default state, no modules are disabled.

28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at <http://www.microchip.com/packaging>



Dimension	Units	MILLIMETERS		
	Limits	MIN	NOM	MAX
Number of Pins	N	28		
Pitch	e	0.65 BSC		
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3	0.20 REF		
Overall Width	E	6.00 BSC		
Exposed Pad Width	E2	3.65	3.70	4.20
Overall Length	D	6.00 BSC		
Exposed Pad Length	D2	3.65	3.70	4.20
Terminal Width	b	0.23	0.30	0.35
Terminal Length	L	0.50	0.55	0.70
Terminal-to-Exposed Pad	K	0.20	-	-

Notes:

- Pin 1 visual index feature may vary, but must be located within the hatched area.
- Package is saw singulated
- Dimensioning and tolerancing per ASME Y14.5M.
BSC: Basic Dimension. Theoretically exact value shown without tolerances.
REF: Reference Dimension, usually without tolerance, for information purposes only.

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